

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT DISPLAY



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: ACDC56-41ZGWA-F01 Green

Features

- 0.56 inch digit height.
- Low current operation.
- Excellent character appearance.
- Mechanically rugged.
- Gray face, white segment.
- Package: 200pcs/ reel.
- Moisture sensitivity level : level 2a.
- RoHS compliant.

Description

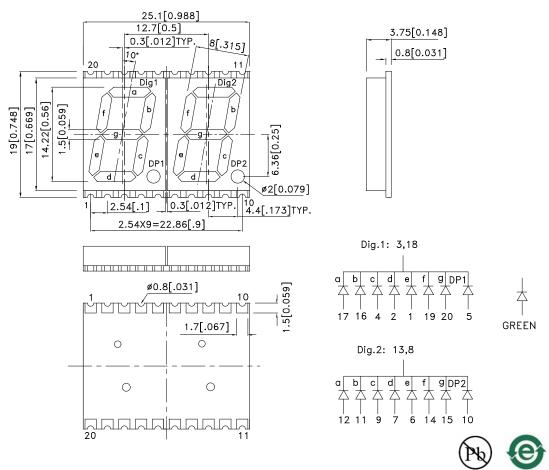
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions& Internal Circuit Diagram



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

3.The gap between the reflector and PCB shall not exceed 0.25mm.

 SPEC NO: DSAK0390
 REV NO: V.3
 DATE: MAR/19/2011
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 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: J.Yu
 ERP: 1352000566

Selection Guide

Part No.	Dice	Lens Type	lv (uc @ 10	,	Description
		,	Min.	Тур.	·
ACDC56-41ZGWA-F01	Green (InGaN)	White Diffused	88000	220000	Common Cathode,Rt. Hand Decimal

Note:

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
lr	Reverse Current	Green		50	uA	VR=5V

Absolute Maximum Ratings at TA=25°C

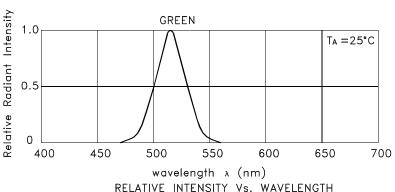
Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating / Storage Temperature	ture -40°C To +85°C		

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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^{1.} Luminous intensity/ luminous Flux: +/-15%.

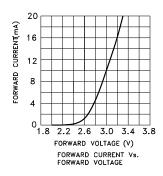
Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

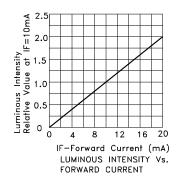


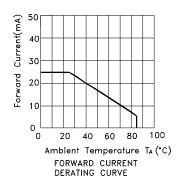
RELATIVE INTENSITY Vs. WAVELENGTH

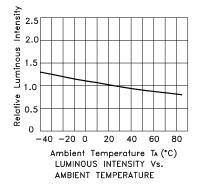
Green

ACDC56-41ZGWA-F01



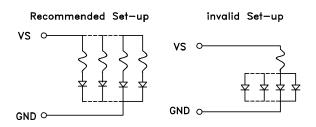






CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



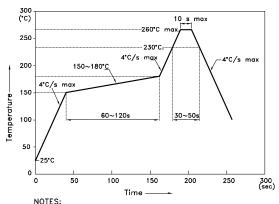
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ACDC56-41ZGWA-F01

Reflow Soldering Profile For Lead-free SMT Process.



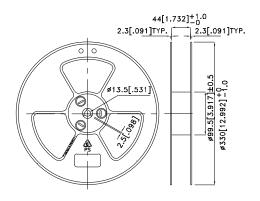
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

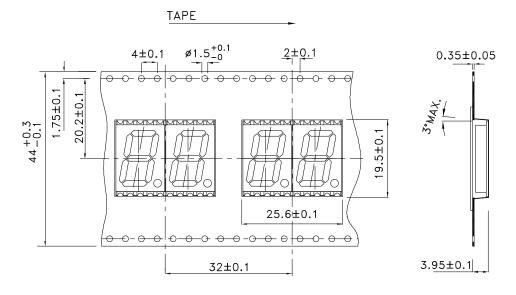
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.15)

2.54X9 = 22.862.54 1.7

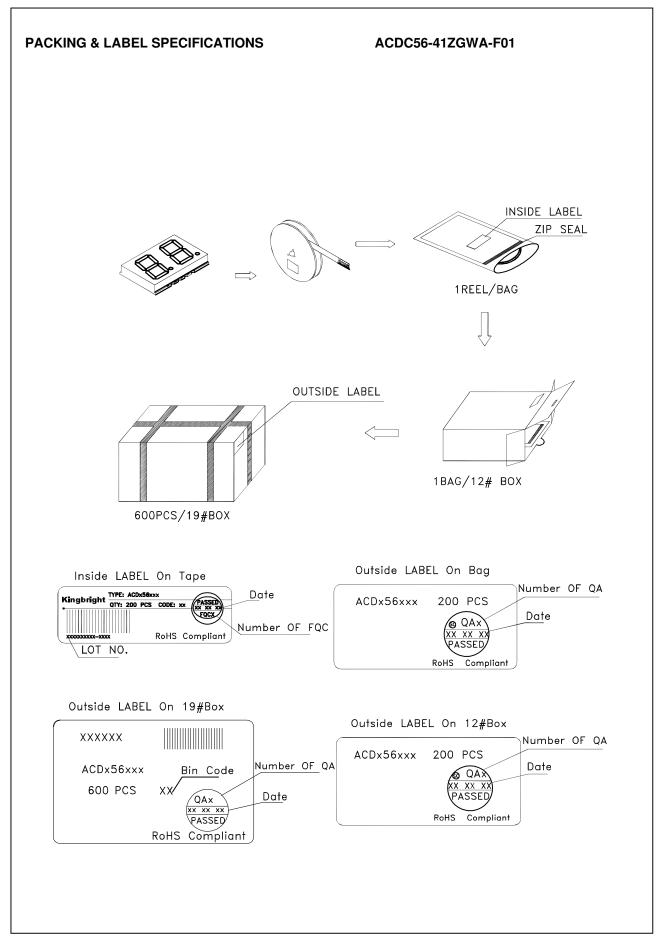
Reel Dimension



Tape Specifications (Units: mm)



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